專利條例(第514章)

指明表格公告

現依據《專利條例》(第 514 章)(「條例」)第 150 條,公布由 2020 年 7 月 17 日起,在進行與下述有關的法律程序時,須使用下列指明及本公告夾附的表格(僅英文版本):

法律程序的描述 表格編號 費用編號

根據條例第 15、16、22 條及《專利(一般) P4 規則》第 8、18 條就一項轉錄標準專利請求 記錄指定專利申請

根據條例第 113、116、125 條及《專利(一 <u>P6</u> 6,8,10 般)規則》第 58、74 條請求批予短期專利

在 2020 年 7 月 17 日至 2021 年 1 月 17 日的過渡期 (「該過渡期」)間,在 2019年 12 月 13 日於香港知識產權公報(英文版本)公布的「指明表格公告」(「<u>先前公告(英文版本)</u>」)中所指明的表格 P4 及 P6 的英文版本,仍可繼續在先前公告(英文版本)所述的相關法律程序中使用。

本公告的英文版本將由該過渡期屆滿日起,就涉及的表格 P4 及 P6 (英文版本)而言,在適用範圍內取代先前公告(英文版本)。

為免生疑問,在 2019 年 12 月 13 日於香港知識產權公報(中文版本)公布的「指明表格公告」(「<u>先前公告(中文版本)</u>」)中所指明的表格 P4 及 P6 的中文版本,仍可繼續在先前公告(中文版本)所述的相關法律程序中使用,不會受本公告影響。

2020年7月10日

專利註冊處處長 黃福來

4, 7, 9

知識產權署 Intellectual Property Department

For official use	
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Patents Form P4

Request to record a designated patent application for a standard patent (R)

Patents Ordinance (Cap. 514)
Patents (General) Rules (Cap. 514C)

Important notes

1. General notes:

- a. This form is available in Chinese and English. Either Chinese or English can be used as the language of proceedings. Please complete this form in English unless otherwise stated. The language of proceedings will be in English.
- b. By submitting this form, you will be treated as having given consent to the Patents Registry and its service provider to copy or communicate all the information provided to any third party (in or outside Hong Kong) who assists or supports the Patents Registry in performing its functions under the Patents Ordinance, Cap. 514 and its subsidiary legislation.
- c. This form must be signed and dated.
- d. If there is not enough space for any part on this form, please continue on an additional sheet. Number each additional sheet and state the number of additional sheet(s) in Part 11(a).
- e. Please enquire through the following means:
 - E-mail: enquiry@ipd.gov.hk
 - Internet homepage address: www.ipd.gov.hk
- f. The Patents Ordinance, Cap 514 and Patents (General) Rules, Cap 514C can be viewed at www.ipd.gov.hk.

2. Use of personal data:

Personal data collected by the Registrar of Patents ("the Registrar") in the forms filed with the Registrar will be used for the purposes set out in the Personal Information Collection Statement at https://www.ipd.gov.hk/eng/personal information.htm.

3. Use of other information:

- a. The Patents Registry will use any information relating to any commercial enterprise or entity provided in this form and any document(s) filed in relation to it for processing your application, request or notice, and for the purposes of collection set out in the Personal Information Collection Statement at https://www.ipd.gov.hk/eng/personal information.htm. They may be made available for public inspection, in full or in part, pursuant to section 147 of the Patents Ordinance, Cap. 514. Such information may be accessed through the Internet.
- b. DO NOT include any business information of your own or that of third parties which you consider to be confidential or commercially sensitive. Where such information is included in this form or any document(s) filed in relation to it, the Registrar will treat it an express and voluntary consent given by you and any such third party to disclosure of all such information for the purpose of public inspection.

4. Submission of application/request/notice:

- a. In person or by mail with the appropriate fee to the Registrar of Patents, 24/F, Wu Chung House, No. 213 Queen's Road East, Wanchai, Hong Kong. The fee schedule can be viewed at www.ipd.gov.hk/eng/forms_fees.htm. Payment can be made in person by cash, or by sending a cheque/bank draft (in Hong Kong dollars which can be cleared in Hong Kong) made payable to THE GOVERNMENT OF THE HONG KONG SPECIAL ADMINISTRATIVE REGION.
- b. This form can also be submitted electronically. For details, please visit IPD's e-Filing System.

5. Abbreviation:

The abbreviation "CNIPA" in Part 06(f) stands for the "National Intellectual Property Administration, People's Republic of China" which was formerly known as the "State Intellectual Property Office, People's Republic of China".

01.	Reference			
	Filer's reference			
02.	Details of applicant(s)			
	If there is more than one applicant, ple	ease provide	e details of <u>all</u> applicants.	
	(a) Name in English If your name is not in Roman letters or in Chinese, please include a transliteration in Roman letters.			
	(b) Name in Chinese (if applicable)			
	(c) Address	Flat/Floor/Bu	illding	
		Street/Distric	t/City	
		Country/Terr	itory/Area	
	(d) Applicant type Please mark <u>one</u> box only.	☐ Incorp	dual Go to Part 03 porated Go to Part 02(e) (and Part 02(f) if applicable) orporated Go to Part 03	
	(e) Country/Territory/Area of incorporation			
	(f) State of incorporation For applicant incorporated in the United States.			
03.	Statement of entitlement to appl	У		
		-	I as the applicant in the designated patent application.	
	mark the following box(es) for providir the grant of a standard patent (R) for	n named as the applicant in the designated patent application, pleasoviding a statement explaining the applicant's entitlement to apply for the invention and submit the prescribed documents supporting Patents Ordinance and section 9, Patents (General) Rules)		
	Statement Please mark the appropriate box(es).		By virtue of assignment By virtue of merger Others (please specify)	

04.	. Title of invention				
	You must state the title of the invention in both English and Chinese.				
	(a) English				
	(b) Chinese				
05.	Details of designated patent app	blication			
	(a) Application no.				
	(b) Filing date	DD-MM-YYYY			
	(c) Designated patent office				
	Please mark <u>one</u> box only.	☐ CN / ☐ EP(GB) / ☐ GB			
	(d) Publication no.	Example: 16102178			
	(if any)				
	(e) Publication date (if any)	DD-MM-YYYY			
06.	Details of international applicati	on			
	Go to Part 07 if the designated patent	application is NOT based on an international application.			
		based on an international application, please provide the following se and section 15, Patents (General) Rules)			
	(a) International application no.				
	(b) International filing date	DD-MM-YYYY			
	-				
	(c) International publication no.				
	(d) International publication date	DD-MM-YYYY			

			P4-
	5.		DD-MM-YYYY
	6.		DD-MM-YYYY
	o .		
09.	Statement of inventorship		
	Go to Part 10 if the designated paten	t application conta	ins the inventor's name.
	If the designated patent application didentifying the person(s) the applicant		he inventor's name, please provide a statement e inventor(s).
	If the name of the inventor is not in Roletters.	oman letters or in Cl	ninese, please include a transliteration in Roman
	Name in Englis	sh	Name in Chinese (if applicable)
	1.		
	2.		
	3.		
	4.		
	5.		
	6.		
10	Statement of non projudicial div	solosuro	
10.	Statement of non-prejudicial dis Go to Part 11 if you do NOT claim no		auro
		-	ease provide a statement indicating the following
			e)(f), Patents Ordinance and section 10, Patents
	(a) Name of the exhibition or meeting		
	(b) Place of the exhibition or meeting		
	(c) Opening date of the exhibition or meeting	DD-MM-YYYY	

DD-MM-YYYY

(d) Date of first disclosure
(if the first disclosure did not take place
on the opening date of such exhibition
or meeting)

11.	List of documents			
	Please enter the no. of sheets of attac	ched document(s), if any, in the	ne following box(es).	
	(a) Additional sheet(s) attached to t	his form		sheet(s)
	(b) Copy of the designated patent a	pplication as published		sheet(s)
	(c) In the case of an international ap	oplication, copy of:		
	(i) the international application International Bureau	as published by the		sheet(s)
	(ii) translation of the international at the designated patent office	application published by		sheet(s)
	(iii) publication of information in the concerning the international app			sheet(s)
	(d) Translation of abstract			sheet(s)
	(e) The prescribed documents sup entitlement to apply mention translation into the language of t in one of the official languages	ed in Part 03 and its		sheet(s)
	(f) Others (please specify)			sheet(s)
12.	Address for service			
	All correspondence and/or document(s) will be sent to the address	below.	
	(a) Name			
	(b) Address You must provide an address for service in Hong Kong. Please note that a P.O. Box or "care of" address is not acceptable.	Flat/Floor/Building Street/District HONG KONG		
	(c) Telephone no. In Hong Kong			
	(d) Fax no. In Hong Kong			

Go to <u>Part 14</u> if you are NOT an agent.				
Please complete this part if you have for the purpose of this request.	been duly authorized to act as an agent on behalf of the applicant(s)			
(a) Name				
(b) Address You must provide an address in Hong Kong where you reside or carry on your business activities. Please note that a P.O. Box or "care of" address is not	Flat/Floor/Building			
acceptable.	Street/District			
	HONG KONG			
14. Signature				
_	d understood the "Important notes" of this form.			
(a) Authorized signature				
(b) Name of signatory				
(c) Official capacity of signatory Examples: Authorized person, Director, Partner or Principal Officer of Applicant(s)/Agent; Applicant in person				
(d) Date	DD-MM-YYYY			

13. Agent's details



	<u> </u>
For official use	

Patents Form P6

Request for grant of a short-term patent

Patents Ordinance (Cap. 514)
Patents (General) Rules (Cap. 514C)

Important notes

1. General notes:

- a. This form is available in Chinese and English. Either Chinese or English can be used as the language of proceedings. Please complete this form in English unless otherwise stated. The specification must be in English.
- b. By submitting this form, you will be treated as having given consent to the Patents Registry and its service provider to copy or communicate all the information provided to any third party (in or outside Hong Kong) who assists or supports the Patents Registry in performing its functions under the Patents Ordinance, Cap. 514 and its subsidiary legislation.
- c. This form must be signed and dated.
- d. If there is not enough space for any part on this form, please continue on an additional sheet. Number each additional sheet and state the number of additional sheet(s) in Part 13(a).
- e. Please enquire through the following means:
 - E-mail: enquiry@ipd.gov.hk
 - Internet homepage address: www.ipd.gov.hk
- f. The Patents Ordinance, Cap. 514 and Patents (General) Rules, Cap. 514C can be viewed at www.ipd.gov.hk.

2. Use of personal data:

Personal data collected by the Registrar of Patents ("the Registrar") in the forms filed with the Registrar will be used for the purposes set out in the Personal Information Collection Statement at https://www.ipd.gov.hk/eng/personal information.htm.

3. Use of other information:

- a. The Patents Registry will use any information relating to any commercial enterprise or entity provided in this form and any document(s) filed in relation to it for processing your application, request or notice, and for the purposes of collection set out in the Personal Information Collection Statement at https://www.ipd.gov.hk/eng/personal information.htm. They may be made available for public inspection, in full or in part, pursuant to section 147 of the Patents Ordinance, Cap. 514. Such information may be accessed through the Internet.
- b. **DO NOT** include any business information of your own or that of third parties which you consider to be confidential or commercially sensitive. Where such information is included in this form or any document(s) filed in relation to it, the Registrar will treat it an express and voluntary consent given by you and any such third party to disclosure of all such information for the purpose of public inspection.

4. Submission of application/request/notice:

- a. In person or by mail with the appropriate fee to the Registrar of Patents, 24/F, Wu Chung House, No. 213 Queen's Road East, Wanchai, Hong Kong. The fee schedule can be viewed at http://www.ipd.gov.hk/eng/forms_fees.htm. Payment can be made in person by cash, or by sending a cheque/bank draft (in Hong Kong dollars which can be cleared in Hong Kong) made payable to THE GOVERNMENT OF THE HONG KONG SPECIAL ADMINISTRATIVE REGION.
- b. This form can also be submitted electronically. For details, please visit IPD's e-Filing System.

5. Abbreviation:

The abbreviation "CNIPA" in Parts 06(e) and 13(j)(iii) & (iv) stands for the "National Intellectual Property Administration, People's Republic of China" which was formerly known as the "State Intellectual Property Office, People's Republic of China".

1. Reference				
Filer's reference				
02. Details of applicant(s)				
If there is more than one applicant, pl	ease provide details of <u>all</u> applicants.			
(a) Name in English If your name is not in Roman letters or in Chinese, please include a transliteration in Roman letters.				
(b) Name in Chinese (if applicable)				
(c) Address	Flat/Floor/Building			
	Street/District/City			
	Country/Territory/Area			
(d) Applicant type Please mark <u>one</u> box only.	☐ Individual Go to Part 03 ☐ Incorporated Go to Part 02(e) (and Part 02(f) if applicable) ☐ Unincorporated Go to Part 03			
(e) Country/Territory/Area of incorporation				
(f) State of incorporation For applicant incorporated in the United States.				
03. Title of invention				
You must state the title of the invention	n in both English and Chinese.			
(a) English				
(b) Chinese				

04. Number of independent claim(s)			P6-3	
The number of independent claim(s) must not exceed two. (Section 113(1A)(b)(ii), Patents Ordinance)				
North or of the day on do of a later (a) and				
Number of independent claim(s) pro	ovided in ti	ne specification		
05. Use of micro-organisms				
Go to Part 06 if the invention does NO	T require th	e use of a micro-organism for its performance.		
If the invention requires the use of a box(es). (Section 73 and Schedule 1, I		anism for its performance, please mark the appropeneral) Rules)	oriate	
(a) Is the micro-organism available to the public at the date of filing of the application; and	Yes	□ No		
(b) Is the micro-organism described in the application or the specification of the patent in such a manner as to enable the invention to be performed by a person skilled in the art.	Yes	□ No		
(c) If you have marked "No" in both	n boxes in	(a) and (b), please provide the following details:		
(i) Name of the depositary institution				
(ii) Address of the depositary institution				
(iii) Date of deposit	DD-MM-YY	YY		
(iv) Accession no. of the deposit				
06. Details of international application	nn -			
•		is NOT based on an international application.		
If the short-term patent application is details. (Section 125, Patents Ordinan		an international application, please provide the follo tion 78, Patents (General) Rules)	wing	
(a) International application no.				
(b) International filing date	DD-MM-YY	YY		

(c) International publication no.

		P6-4
(d) International publication date	DD-MM-YYYY	
(e) Date of entry into the national phase in the People's Republic of China	DD-MM-YYYY	
or		
Date of issuance of an official notification by the CNIPA as prescribed under section 78 of the Patents (General) Rules	DD-MM-YYYY	
(f) Application no. of the Chinese patent application (if known)		
07. Statement of reference to an ea	arlier specified applica	ation
please provide a statement by mark	d application under section	cified application. on 114(3)(c)(ii), Patents Ordinance is made, ovide the following details. (Sections 58(5)(i)
and 67A, Patents (General) Rules).		
	patent application, are	s (if any) of the invention, which is the completely contained in the following
subject of the short-term	patent application, are	
subject of the short-term earlier specified applicati	patent application, are on: Earlier specified	completely contained in the following Earlier specified application
subject of the short-term earlier specified applicati	patent application, are on: Earlier specified	completely contained in the following Earlier specified application filing date
subject of the short-term earlier specified applicati Country/Territory/Area 08. Details of earlier application	patent application, are on: Earlier specified application no.	Earlier specified application filing date
subject of the short-term earlier specified applicati Country/Territory/Area 08. Details of earlier application Go to Part 09 if you do NOT claim the	patent application, are on: Earlier specified application no.	Earlier specified application filing date
subject of the short-term earlier specified application Country/Territory/Area 08. Details of earlier application Go to Part 09 if you do NOT claim the lift the application is divided or deriven.	patent application, are on: Earlier specified application no.	Earlier specified application filing date DD-MM-YYYY application. ong application, please provide the following application (section 116, Patents
subject of the short-term earlier specified applicati Country/Territory/Area 08. Details of earlier application Go to Part 09 if you do NOT claim the lf the application is divided or derived details. (a) Type	patent application, are on: Earlier specified application no. The filing date of an earlier of the from an earlier Hong Kordinance of the Divisional Ordinance of the New application not the determination.	Earlier specified application filing date DD-MM-YYYY application. ong application, please provide the following application (section 116, Patents
subject of the short-term earlier specified applicati Country/Territory/Area 08. Details of earlier application Go to Part 09 if you do NOT claim the lf the application is divided or derived details. (a) Type	patent application, are on: Earlier specified application no. The filing date of an earlier of the from an earlier Hong Kordinance of the Divisional Ordinance of the New application not the determination.	Earlier specified application filing date DD-MM-YYYY application. ong application, please provide the following application (section 116, Patents) lication filed on court order upon tion of right to patent after grant (section

09. Statement of priority claim

Go to Part 10 if you do NOT claim priority.

If a claim of priority under section 111, Patents Ordinance is made, please provide a statement of the following details. (Sections 58(5)(c), 69, Patents (General) Rules)

_		Country/Territory/Area	Priority applicat	ion no.	Priority application filing date
	1.				DD-MM-YYYY
	2.				DD-MM-YYYY
	3.				DD-MM-YYYY
	J.				
10.	Nam	ne(s) of inventor(s) (invent	tor must be indivi	dual not c	ompany)
	appli		apply for a short-terr	n patent for	the inventor(s) and indicating how the rethe invention must be made on Form s (General) Rules)
	If the letter		Roman letters or in 0	Chinese, pl	ease include a transliteration in Roman
		Name in Er	nglish	Na	ame in Chinese (if applicable)
	1.				
	2.				
	3.				
	4.				
	₩.				
	5.				
11.	Stat	ement of non-prejudicial o	disclosure		
	Go t	o <u>Part 12</u> if you do NOT claim	non-prejudicial disclo	sure.	
	Ordir evide	nance, please provide a state	ement giving details	relating to	sclosure under section 109, Patents such disclosure and provide written ance and sections 58(5)(f), 70, Patents
	(a) S	tatement			

			P6-6
(b) Name of the exhibition			
(c) Place of the exhibition			
(d) Opening date of the exhibition	DD-MM-YYYY		
(e) Date of first disclosure (if the first disclosure did not take place on the opening date of such exhibition)	DD-MM-YYYY		
12. Deferral of Grant			
Go to <u>Part 13</u> if you do NOT request d	leferral of grant.		
If a request for deferral of grant under of such deferral.	section 119, Patents Ordinar	nce is required, please	enter the period
Deferral of grant up to (The period of deferral should not exceed 12 months)	DD-MM-YYYY		
13. List of documents			
Please enter the no. of sheets of attac	ched document(s), if any, in th	ne following box(es).	
(a) Additional sheet(s) attached to t	this form		sheet(s)
(b) Description			sheet(s)
(c) Claim(s)			sheet(s)
(d) Drawing(s)			sheet(s)
(e) Abstract (in both English and C	hinese)		sheet(s)
(f) Priority document(s)			sheet(s)
(g) Translation of the priority doc application is not in one of the c			sheet(s)
(h) Search report			sheet(s)
(i) Translation of the search report languages)	(if not in one of the official		sheet(s)
(j) In the case of an international a	pplication, copy of:		
(i) the international applicat International Bureau	ion as published by the		sheet(s)

(ii) the international search re	eport	sheet(s)
(iii) translation of the inte published by the CNIPA	rnational application as	sheet(s)
(iv) information as published the international application		sheet(s)
(k) Statement of inventorship on I	Form P6A	sheet(s)
(I) Sequence listing if the inventio amino acid sequences	on involves nucleotide and	sheet(s)
(Sequence listing may be filed in electro patent application is not filed by way of ele		
(m) Others (please specify)		sheet(s)
44 Address for some		
14. Address for service All correspondence and/or document	(c) will be cent to the address below	
·	(s) will be sent to the address below.	
(a) Name		
(b) Address You must provide an address for service in Hong Kong. Please note	Flat/Floor/Building	
that a P.O. Box or "care of" address is not acceptable.	Street/District	
	HONG KONG	
(c) Telephone no. In Hong Kong		
(d) Fax no. In Hong Kong		
15. Agent's details		
Go to <u>Part 16</u> if you are NOT an agen	ıt.	
Please complete this part if you have to for the purpose of this request.	oeen duly authorized to act as an agent on bo	ehalf of the Applicant(s)
(a) Name		
(b) Address You must provide an address in Hong Kong where you reside or carry on your	Flat/Floor/Building	
business activities. Please note that a P.O. Box or "care of" address is not acceptable.	Street/District	
	HONG KONG	

		1 0-0
16.	Signature	
	I/We confirm that I/we have read and u	inderstood the "Important notes" of this form.
	(a) Authorized signature	
	(b) Name of signatory	
	(c) Official capacity of signatory Examples: Authorized person, Director, Partner or Principal Officer of Applicant(s)/Agent; Applicant in person	
	(d) Date	DD-MM-YYYY